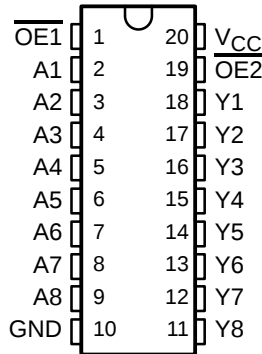


# SN54BCT541, SN74BCT541A OCTAL BUFFERS/DRIVERS WITH 3-STATE OUTPUTS

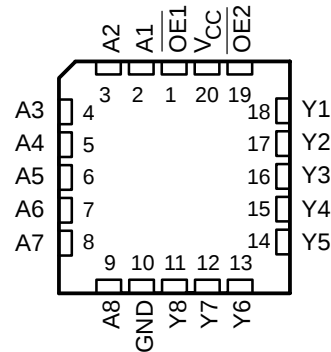
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- Operating Voltage Range of 4.5 V to 5.5 V
- State-of-the-Art BiCMOS Design Significantly Reduces  $I_{CCZ}$
- 3-State Outputs Drive Bus Lines or Buffer Memory Address Registers
- P-N-P Inputs Reduce DC Loading
- Data Flow-Through Pinout (All Inputs on Opposite Side From Outputs)

SN54BCT541 ... J OR W PACKAGE  
SN74BCT541A ... DW, N, OR NS PACKAGE  
(TOP VIEW)



SN54BCT541 ... FK PACKAGE  
(TOP VIEW)



## description/ordering information

The SN54BCT541 and SN74BCT541A octal buffers and line drivers are ideal for driving bus lines or buffering memory-address registers. The devices feature inputs and outputs on opposite sides of the package to facilitate printed-circuit-board layout.

The 3-state control gate is a 2-input AND gate with active-low inputs so that, if either output-enable ( $\overline{OE1}$  or  $\overline{OE2}$ ) input is high, all eight outputs are in the high-impedance state.

To ensure the high-impedance state during power up or power down,  $\overline{OE}$  should be tied to  $V_{CC}$  through a pullup resistor; the minimum value of the resistor is determined by the current-sinking capability of the driver.

## ORDERING INFORMATION

| T <sub>A</sub> | PACKAGE <sup>†</sup> |               | ORDERABLE PART NUMBER | TOP-SIDE MARKING |
|----------------|----------------------|---------------|-----------------------|------------------|
| 0°C to 70°C    | PDIP – N             | Tube          | SN74BCT541AN          | BCT541A          |
|                | SOIC – DW            | Tube          | SN74BCT541ADW         |                  |
|                |                      | Tape and reel | SN74BCT541ADWR        |                  |
|                | SOP – NS             | Tape and reel | SN74BCT541ANSR        | BCT541A          |
| –55°C to 125°C | CDIP – J             | Tube          | SNJ54BCT541J          | SNJ54BCT541J     |
|                | CFP – W              | Tube          | SNJ54BCT541W          | SNJ54BCT541W     |
|                | LCCC – FK            | Tube          | SNJ54BCT541FK         | SNJ54BCT541FK    |

<sup>†</sup> Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at [www.ti.com/sc/package](http://www.ti.com/sc/package).



Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.

PRODUCTION DATA information is current as of publication date. Products conform to specifications per the terms of Texas Instruments standard warranty. Production processing does not necessarily include testing of all parameters.

**TEXAS  
INSTRUMENTS**

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On products compliant to MIL-PRF-38535, all parameters are tested unless otherwise noted. On all other products, production processing does not necessarily include testing of all parameters.

# SN54BCT541, SN74BCT541A

## OCTAL BUFFERS/DRIVERS

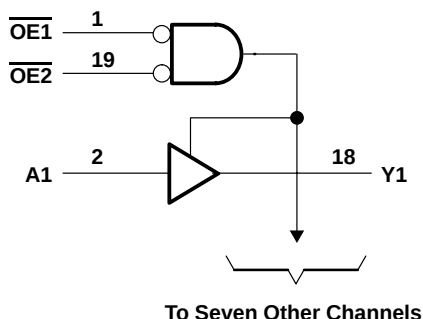
### WITH 3-STATE OUTPUTS

SCBS011E – JULY 1988 – REVISED MARCH 2003

FUNCTION TABLE

| INPUTS           |                  |   | OUTPUT |
|------------------|------------------|---|--------|
| $\overline{OE1}$ | $\overline{OE2}$ | A | Y      |
| L                | L                | L | L      |
| L                | L                | H | H      |
| H                | X                | X | Z      |
| X                | H                | X | Z      |

#### logic diagram (positive logic)



#### absolute maximum ratings over operating free-air temperature range (unless otherwise noted)<sup>†</sup>

|                                                                               |                    |
|-------------------------------------------------------------------------------|--------------------|
| Supply voltage range, $V_{CC}$                                                | –0.5 V to 7 V      |
| Input voltage range, $V_I$ (see Note 1)                                       | –0.5 V to 7 V      |
| Voltage range applied to any output in the disabled or power-off state, $V_O$ | –0.5 V to 5.5 V    |
| Voltage range applied to any output in the high state, $V_O$                  | –0.5 V to $V_{CC}$ |
| Current into any output in the low state: SN54BCT541                          | 96 mA              |
| SN74BCT541A                                                                   | 128 mA             |
| Package thermal impedance, $\theta_{JA}$ (see Note 2): DW package             | 58°C/W             |
| N package                                                                     | 69°C/W             |
| NS package                                                                    | 60°C/W             |
| Storage temperature range, $T_{stg}$                                          | –65°C to 150°C     |

<sup>†</sup> Stresses beyond those listed under “absolute maximum ratings” may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under “recommended operating conditions” is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTES: 1. The input and output voltage ratings may be exceeded if the input and output current ratings are observed.  
2. The package thermal impedance is calculated in accordance with JESD 51-7.

#### recommended operating conditions (see Note 3)

|          |                                | SN54BCT541 |     |     | SN74BCT541A |     |     | UNIT |
|----------|--------------------------------|------------|-----|-----|-------------|-----|-----|------|
|          |                                | MIN        | NOM | MAX | MIN         | NOM | MAX |      |
| $V_{CC}$ | Supply voltage                 | 4.5        | 5   | 5.5 | 4.5         | 5   | 5.5 | V    |
| $V_{IH}$ | High-level input voltage       | 2          |     |     | 2           |     |     | V    |
| $V_{IL}$ | Low-level input voltage        |            |     | 0.8 |             |     | 0.8 | V    |
| $I_{IK}$ | Input clamp current            |            |     | –18 |             |     | –18 | mA   |
| $I_{OH}$ | High-level output current      |            |     | –12 |             |     | –15 | mA   |
| $I_{OL}$ | Low-level output current       |            |     | 48  |             |     | 64  | mA   |
| $T_A$    | Operating free-air temperature | –55        | 125 |     | 0           | 70  |     | °C   |

NOTE 3: All unused inputs of the device must be held at  $V_{CC}$  or GND to ensure proper device operation. Refer to the TI application report, *Implications of Slow or Floating CMOS Inputs*, literature number SCBA004.



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# SN54BCT541, SN74BCT541A

## OCTAL BUFFERS/DRIVERS

### WITH 3-STATE OUTPUTS

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electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

| PARAMETER           | TEST CONDITIONS                                                   |                          | SN54BCT541 |                  |      | SN74BCT541A |                  |      | UNIT          |
|---------------------|-------------------------------------------------------------------|--------------------------|------------|------------------|------|-------------|------------------|------|---------------|
|                     |                                                                   |                          | MIN        | TYP <sup>†</sup> | MAX  | MIN         | TYP <sup>†</sup> | MAX  |               |
| $V_{IK}$            | $V_{CC} = 4.5\text{ V}$ ,<br>$I_I = -18\text{ mA}$                |                          |            |                  | -1.2 |             |                  | -1.2 | V             |
| $V_{OH}$            | $V_{CC} = 4.5\text{ V}$                                           | $I_{OH} = -3\text{ mA}$  | 2.4        | 3.3              |      | 2.4         | 3.3              |      | V             |
|                     |                                                                   | $I_{OH} = -12\text{ mA}$ | 2          | 3.2              |      |             |                  |      |               |
|                     |                                                                   | $I_{OH} = -15\text{ mA}$ |            |                  |      | 2           | 3.1              |      |               |
| $V_{OL}$            | $V_{CC} = 4.5\text{ V}$                                           | $I_{OL} = 48\text{ mA}$  |            | 0.38             | 0.55 |             |                  |      | V             |
|                     |                                                                   | $I_{OL} = 64\text{ mA}$  |            |                  |      | 0.42        | 0.55             |      |               |
| $I_I$               | $V_{CC} = 5.5\text{ V}$ ,<br>$V_I = 7\text{ V}$                   |                          |            |                  | 0.1  |             |                  | 0.1  | mA            |
| $I_{IH}$            | $V_{CC} = 5.5\text{ V}$ ,<br>$V_I = 2.7\text{ V}$                 |                          |            |                  | 20   |             |                  | 20   | $\mu\text{A}$ |
| $I_{IL}$            | $V_{CC} = 5.5\text{ V}$ ,<br>$V_I = 0.5\text{ V}$                 |                          |            |                  | -0.6 |             |                  | -0.6 | mA            |
| $I_{OZH}$           | $V_{CC} = 5.5\text{ V}$ ,<br>$V_O = 2.7\text{ V}$                 |                          |            |                  | 50   |             |                  | 50   | $\mu\text{A}$ |
| $I_{OZL}$           | $V_{CC} = 5.5\text{ V}$ ,<br>$V_O = 0.5\text{ V}$                 |                          |            |                  | -50  |             |                  | -50  | $\mu\text{A}$ |
| $I_{OS}^{\ddagger}$ | $V_{CC} = 5.5\text{ V}$ ,<br>$V_O = 0$                            |                          | -100       |                  | -225 | -100        |                  | -225 | mA            |
| $I_{CCH}$           | $V_{CC} = 5.5\text{ V}$                                           |                          |            | 27               | 40   |             | 27               | 40   | mA            |
| $I_{CCL}$           | $V_{CC} = 5.5\text{ V}$                                           |                          |            | 47               | 72   |             | 47               | 72   | mA            |
| $I_{CCZ}$           | $V_{CC} = 5.5\text{ V}$                                           |                          |            | 5                | 7    |             | 5                | 7    | mA            |
| $C_i$               | $V_{CC} = 5\text{ V}$ ,<br>$V_I = 2.5\text{ V}$ or $0.5\text{ V}$ |                          |            | 5                |      |             | 5                |      | pF            |
| $C_o$               | $V_{CC} = 5\text{ V}$ ,<br>$V_O = 2.5\text{ V}$ or $0.5\text{ V}$ |                          |            | 10               |      |             | 10               |      | pF            |

<sup>†</sup> All typical values are at  $V_{CC} = 5\text{ V}$ ,  $T_A = 25^\circ\text{C}$ .

<sup>‡</sup> Not more than one output should be tested at a time, and the duration of the test should not exceed one second.

### switching characteristics (see Figure 1)

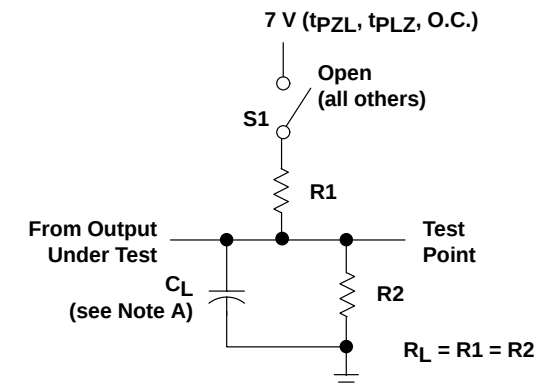
| PARAMETER | FROM<br>(INPUT) | TO<br>(OUTPUT) | VCC = 5 V,<br>CL = 50 pF,<br>R1 = 500 Ω,<br>R2 = 500 Ω,<br>TA = 25°C |     |      | VCC = 4.5 V to 5.5 V,<br>CL = 50 pF,<br>R1 = 500 Ω,<br>R2 = 500 Ω,<br>TA = MIN to MAX§ |      |             |      | UNIT |
|-----------|-----------------|----------------|----------------------------------------------------------------------|-----|------|----------------------------------------------------------------------------------------|------|-------------|------|------|
|           |                 |                | 'BCT541                                                              |     |      | SN54BCT541                                                                             |      | SN74BCT541A |      |      |
|           |                 |                | MIN                                                                  | TYP | MAX  | MIN                                                                                    | MAX  | MIN         | MAX  |      |
| tPLH      | A               | Y              | 2.1                                                                  | 3.7 | 5.3  | 1.7                                                                                    | 6.3  | 1.7         | 6    | ns   |
| tPHL      |                 |                | 3.7                                                                  | 5.5 | 7.5  | 3.2                                                                                    | 8.7  | 3.4         | 8.2  |      |
| tPZH      | OE              | Y              | 4.5                                                                  | 7.2 | 9.3  | 4.4                                                                                    | 11   | 3.9         | 10.7 | ns   |
| tPZL      |                 |                | 5                                                                    | 8   | 10.4 | 5.4                                                                                    | 12.4 | 4.4         | 11.5 |      |
| tPHZ      | OE              | Y              | 3.5                                                                  | 5.6 | 7.6  | 3                                                                                      | 9.1  | 3           | 8.6  | ns   |
| tPLZ      |                 |                | 3.4                                                                  | 5.2 | 7.2  | 3                                                                                      | 9.4  | 3           | 8.6  |      |

<sup>\S</sup> For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.

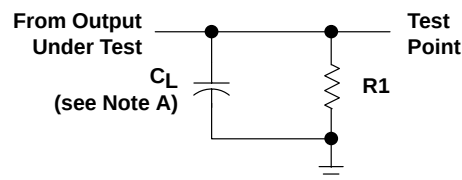
# SN54BCT541, SN74BCT541A OCTAL BUFFERS/DRIVERS WITH 3-STATE OUTPUTS

SCBS011E – JULY 1988 – REVISED MARCH 2003

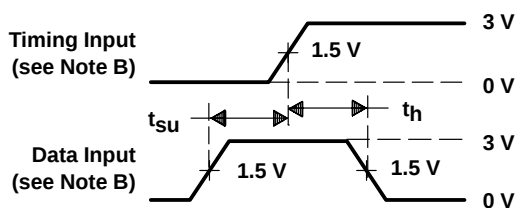
## PARAMETER MEASUREMENT INFORMATION



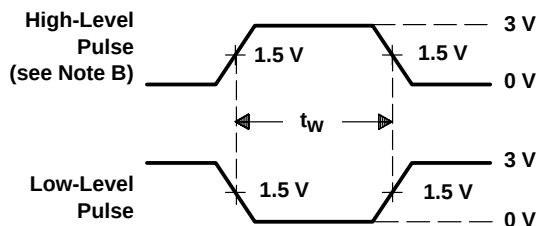
LOAD CIRCUIT FOR  
3-STATE AND OPEN-COLLECTOR OUTPUTS



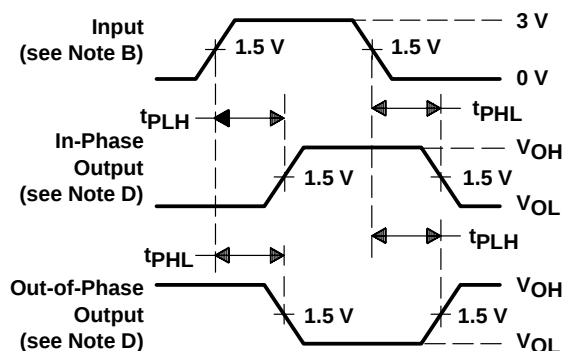
LOAD CIRCUIT FOR  
TOTEM-POLE OUTPUTS



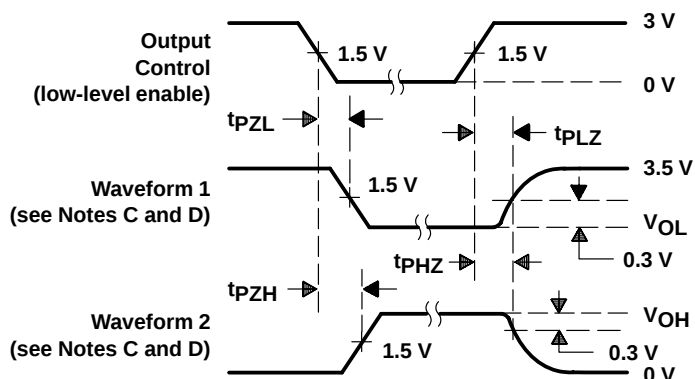
VOLTAGE WAVEFORMS  
SETUP AND HOLD TIMES



VOLTAGE WAVEFORMS  
PULSE DURATION



VOLTAGE WAVEFORMS  
PROPAGATION DELAY TIMES (see Note D)



VOLTAGE WAVEFORMS  
ENABLE AND DISABLE TIMES, 3-STATE OUTPUTS

- NOTES:
- A.  $C_L$  includes probe and jig capacitance.
  - B. All input pulses are supplied by generators having the following characteristics:  $PRR \leq 10$  MHz,  $t_r = t_f \leq 2.5$  ns, duty cycle = 50%.
  - C. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
  - D. The outputs are measured one at a time with one transition per measurement.
  - E. When measuring propagation delay times of 3-state outputs, switch S1 is open.
  - F. All parameters and waveforms are not applicable to all devices.

Figure 1. Load Circuit and Voltage Waveforms

**PACKAGING INFORMATION**

| Orderable Device | Status <sup>(1)</sup> | Package Type | Package Drawing | Pins | Package Qty | Eco Plan <sup>(2)</sup> | Lead/Ball Finish | MSL Peak Temp <sup>(3)</sup> |
|------------------|-----------------------|--------------|-----------------|------|-------------|-------------------------|------------------|------------------------------|
| 5962-9074901M2A  | ACTIVE                | LCCC         | FK              | 20   | 1           | TBD                     | POST-PLATE       | N / A for Pkg Type           |
| 5962-9074901MRA  | ACTIVE                | CDIP         | J               | 20   | 1           | TBD                     | A42              | N / A for Pkg Type           |
| 5962-9074901MSA  | ACTIVE                | CFP          | W               | 20   | 1           | TBD                     | Call TI          | N / A for Pkg Type           |
| SN74BCT541ADW    | ACTIVE                | SOIC         | DW              | 20   | 25          | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| SN74BCT541ADWE4  | ACTIVE                | SOIC         | DW              | 20   | 25          | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| SN74BCT541ADWG4  | ACTIVE                | SOIC         | DW              | 20   | 25          | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| SN74BCT541ADWR   | ACTIVE                | SOIC         | DW              | 20   | 2000        | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| SN74BCT541ADWRE4 | ACTIVE                | SOIC         | DW              | 20   | 2000        | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| SN74BCT541ADWRG4 | ACTIVE                | SOIC         | DW              | 20   | 2000        | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| SN74BCT541AN     | ACTIVE                | PDIP         | N               | 20   | 20          | Pb-Free (RoHS)          | CU NIPDAU        | N / A for Pkg Type           |
| SN74BCT541ANE4   | ACTIVE                | PDIP         | N               | 20   | 20          | Pb-Free (RoHS)          | CU NIPDAU        | N / A for Pkg Type           |
| SN74BCT541ANSR   | ACTIVE                | SO           | NS              | 20   | 2000        | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| SN74BCT541ANSRE4 | ACTIVE                | SO           | NS              | 20   | 2000        | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| SN74BCT541ANSRG4 | ACTIVE                | SO           | NS              | 20   | 2000        | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| SNJ54BCT541FK    | ACTIVE                | LCCC         | FK              | 20   | 1           | TBD                     | POST-PLATE       | N / A for Pkg Type           |
| SNJ54BCT541J     | ACTIVE                | CDIP         | J               | 20   | 1           | TBD                     | A42              | N / A for Pkg Type           |
| SNJ54BCT541W     | ACTIVE                | CFP          | W               | 20   | 1           | TBD                     | Call TI          | N / A for Pkg Type           |

<sup>(1)</sup> The marketing status values are defined as follows:

**ACTIVE:** Product device recommended for new designs.

**LIFEBUY:** TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

**NRND:** Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

**PREVIEW:** Device has been announced but is not in production. Samples may or may not be available.

**OBSELETE:** TI has discontinued the production of the device.

<sup>(2)</sup> Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check <http://www.ti.com/productcontent> for the latest availability information and additional product content details.

**TBD:** The Pb-Free/Green conversion plan has not been defined.

**Pb-Free (RoHS):** TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

**Pb-Free (RoHS Exempt):** This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

**Green (RoHS & no Sb/Br):** TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

<sup>(3)</sup> MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

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**OTHER QUALIFIED VERSIONS OF SN54BCT541 :**

- Catalog: [SN74BCT541](#)

NOTE: Qualified Version Definitions:

- Catalog - TI's standard catalog product

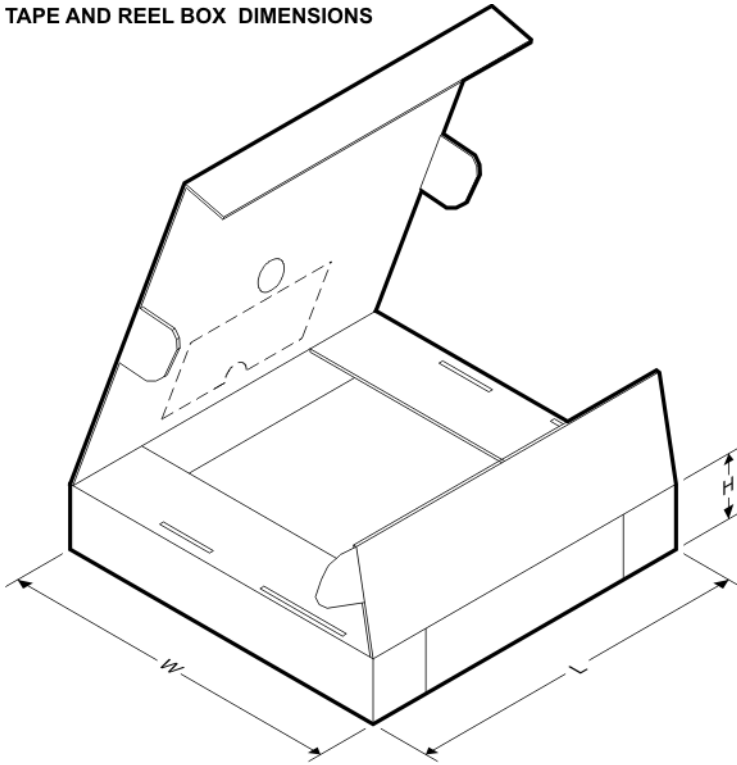
**TAPE AND REEL INFORMATION**



\*All dimensions are nominal

| Device         | Package Type | Package Drawing | Pins | SPQ  | Reel Diameter (mm) | Reel Width W1 (mm) | A0 (mm) | B0 (mm) | K0 (mm) | P1 (mm) | W (mm) | Pin1 Quadrant |
|----------------|--------------|-----------------|------|------|--------------------|--------------------|---------|---------|---------|---------|--------|---------------|
| SN74BCT541ADWR | SOIC         | DW              | 20   | 2000 | 330.0              | 24.4               | 10.8    | 13.0    | 2.7     | 12.0    | 24.0   | Q1            |
| SN74BCT541ANSR | SO           | NS              | 20   | 2000 | 330.0              | 24.4               | 8.2     | 13.0    | 2.5     | 12.0    | 24.0   | Q1            |

## TAPE AND REEL BOX DIMENSIONS



\*All dimensions are nominal

| Device         | Package Type | Package Drawing | Pins | SPQ  | Length (mm) | Width (mm) | Height (mm) |
|----------------|--------------|-----------------|------|------|-------------|------------|-------------|
| SN74BCT541ADWR | SOIC         | DW              | 20   | 2000 | 346.0       | 346.0      | 41.0        |
| SN74BCT541ANSR | SO           | NS              | 20   | 2000 | 346.0       | 346.0      | 41.0        |

FK (S-CQCC-N\*\*)

LEADLESS CERAMIC CHIP CARRIER

28 TERMINAL SHOWN



- NOTES:
- A. All linear dimensions are in inches (millimeters).
  - B. This drawing is subject to change without notice.
  - C. This package can be hermetically sealed with a metal lid.
  - D. The terminals are gold plated.
  - E. Falls within JEDEC MS-004

# MECHANICAL DATA

NS (R-PDSO-G\*\*)

PLASTIC SMALL-OUTLINE PACKAGE

14-PINS SHOWN



| DIM \ PINS ** | 14    | 16    | 20    | 24    |
|---------------|-------|-------|-------|-------|
| A MAX         | 10,50 | 10,50 | 12,90 | 15,30 |
| A MIN         | 9,90  | 9,90  | 12,30 | 14,70 |

4040062/C 03/03

- NOTES:
- A. All linear dimensions are in millimeters.
  - B. This drawing is subject to change without notice.
  - C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15.

J (R-GDIP-T\*\*)

14 LEADS SHOWN

# CERAMIC DUAL IN-LINE PACKAGE



| PINS **<br>DIM | 14                     | 16                     | 18                     | 20                     |
|----------------|------------------------|------------------------|------------------------|------------------------|
| A              | 0.300<br>(7,62)<br>BSC | 0.300<br>(7,62)<br>BSC | 0.300<br>(7,62)<br>BSC | 0.300<br>(7,62)<br>BSC |
| B MAX          | 0.785<br>(19,94)       | .840<br>(21,34)        | 0.960<br>(24,38)       | 1.060<br>(26,92)       |
| B MIN          | —                      | —                      | —                      | —                      |
| C MAX          | 0.300<br>(7,62)        | 0.300<br>(7,62)        | 0.310<br>(7,87)        | 0.300<br>(7,62)        |
| C MIN          | 0.245<br>(6,22)        | 0.245<br>(6,22)        | 0.220<br>(5,59)        | 0.245<br>(6,22)        |



4040083/F 03/03

- NOTES:
- A. All linear dimensions are in inches (millimeters).
  - B. This drawing is subject to change without notice.
  - C. This package is hermetically sealed with a ceramic lid using glass frit.
  - D. Index point is provided on cap for terminal identification only on press ceramic glass frit seal only.
  - E. Falls within MIL STD 1835 GDIP1-T14, GDIP1-T16, GDIP1-T18 and GDIP1-T20.

W (R-GDFP-F20)

CERAMIC DUAL FLATPACK



- NOTES:
- All linear dimensions are in inches (millimeters).
  - This drawing is subject to change without notice.
  - This package can be hermetically sealed with a ceramic lid using glass frit.
  - Index point is provided on cap for terminal identification only.
  - Falls within Mil-Std 1835 GDFP2-F20

DW (R-PDSO-G20)

PLASTIC SMALL-OUTLINE PACKAGE



4040000-4/F 06/2004

- NOTES:
- All linear dimensions are in inches (millimeters).
  - This drawing is subject to change without notice.
  - Body dimensions do not include mold flash or protrusion not to exceed 0.006 (0,15).
  - Falls within JEDEC MS-013 variation AC.

## N (R-PDIP-T\*\*)

16 PINS SHOWN

## PLASTIC DUAL-IN-LINE PACKAGE



| PINS **             | 14               | 16               | 18               | 20               |
|---------------------|------------------|------------------|------------------|------------------|
| DIM                 |                  |                  |                  |                  |
| A MAX               | 0.775<br>(19,69) | 0.775<br>(19,69) | 0.920<br>(23,37) | 1.060<br>(26,92) |
| A MIN               | 0.745<br>(18,92) | 0.745<br>(18,92) | 0.850<br>(21,59) | 0.940<br>(23,88) |
| MS-001<br>VARIATION | AA               | BB               | AC               | AD               |



4040049/E 12/2002

- NOTES:
- A. All linear dimensions are in inches (millimeters).
  - B. This drawing is subject to change without notice.
  - Falls within JEDEC MS-001, except 18 and 20 pin minimum body length (Dim A).
  - The 20 pin end lead shoulder width is a vendor option, either half or full width.

## PACKAGING INFORMATION

| Orderable part number           | Status<br>(1) | Material type<br>(2) | Package   Pins | Package qty   Carrier | RoHS<br>(3) | Lead finish/<br>Ball material<br>(4) | MSL rating/<br>Peak reflow<br>(5) | Op temp (°C) | Part marking<br>(6)                      |
|---------------------------------|---------------|----------------------|----------------|-----------------------|-------------|--------------------------------------|-----------------------------------|--------------|------------------------------------------|
| <a href="#">5962-9074901M2A</a> | Active        | Production           | LCCC (FK)   20 | 55   TUBE             | No          | SNPB                                 | N/A for Pkg Type                  | -55 to 125   | 5962-<br>9074901M2A<br>SNJ54BCT<br>541FK |
| <a href="#">5962-9074901MRA</a> | Active        | Production           | CDIP (J)   20  | 20   TUBE             | No          | SNPB                                 | N/A for Pkg Type                  | -55 to 125   | 5962-9074901MR<br>A<br>SNJ54BCT541J      |
| <a href="#">SN74BCT541ADW</a>   | Obsolete      | Production           | SOIC (DW)   20 | -                     | -           | Call TI                              | Call TI                           | 0 to 70      | BCT541A                                  |
| <a href="#">SN74BCT541ADWR</a>  | Active        | Production           | SOIC (DW)   20 | 2000   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | 0 to 70      | BCT541A                                  |
| SN74BCT541ADWR.A                | Active        | Production           | SOIC (DW)   20 | 2000   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | 0 to 70      | BCT541A                                  |
| <a href="#">SN74BCT541AN</a>    | Active        | Production           | PDIP (N)   20  | 20   TUBE             | Yes         | NIPDAU                               | N/A for Pkg Type                  | 0 to 70      | SN74BCT541AN                             |
| SN74BCT541AN.A                  | Active        | Production           | PDIP (N)   20  | 20   TUBE             | Yes         | NIPDAU                               | N/A for Pkg Type                  | 0 to 70      | SN74BCT541AN                             |
| <a href="#">SN74BCT541ANSR</a>  | Active        | Production           | SOP (NS)   20  | 2000   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | 0 to 70      | BCT541A                                  |
| SN74BCT541ANSR.A                | Active        | Production           | SOP (NS)   20  | 2000   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | 0 to 70      | BCT541A                                  |
| <a href="#">SNJ54BCT541FK</a>   | Active        | Production           | LCCC (FK)   20 | 55   TUBE             | No          | SNPB                                 | N/A for Pkg Type                  | -55 to 125   | 5962-<br>9074901M2A<br>SNJ54BCT<br>541FK |
| SNJ54BCT541FK.A                 | Active        | Production           | LCCC (FK)   20 | 55   TUBE             | No          | SNPB                                 | N/A for Pkg Type                  | -55 to 125   | 5962-<br>9074901M2A<br>SNJ54BCT<br>541FK |
| <a href="#">SNJ54BCT541J</a>    | Active        | Production           | CDIP (J)   20  | 20   TUBE             | No          | SNPB                                 | N/A for Pkg Type                  | -55 to 125   | 5962-9074901MR<br>A<br>SNJ54BCT541J      |
| SNJ54BCT541J.A                  | Active        | Production           | CDIP (J)   20  | 20   TUBE             | No          | SNPB                                 | N/A for Pkg Type                  | -55 to 125   | 5962-9074901MR<br>A<br>SNJ54BCT541J      |

<sup>(1)</sup> **Status:** For more details on status, see our [product life cycle](#).

<sup>(2)</sup> **Material type:** When designated, preproduction parts are prototypes/experimental devices, and are not yet approved or released for full production. Testing and final process, including without limitation quality assurance, reliability performance testing, and/or process qualification, may not yet be complete, and this item is subject to further changes or possible discontinuation. If available for ordering, purchases will be subject to an additional waiver at checkout, and are intended for early internal evaluation purposes only. These items are sold without warranties of any kind.

<sup>(3)</sup> **RoHS values:** Yes, No, RoHS Exempt. See the [TI RoHS Statement](#) for additional information and value definition.

<sup>(4)</sup> **Lead finish/Ball material:** Parts may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

<sup>(5)</sup> **MSL rating/Peak reflow:** The moisture sensitivity level ratings and peak solder (reflow) temperatures. In the event that a part has multiple moisture sensitivity ratings, only the lowest level per JEDEC standards is shown. Refer to the shipping label for the actual reflow temperature that will be used to mount the part to the printed circuit board.

<sup>(6)</sup> **Part marking:** There may be an additional marking, which relates to the logo, the lot trace code information, or the environmental category of the part.

Multiple part markings will be inside parentheses. Only one part marking contained in parentheses and separated by a "~" will appear on a part. If a line is indented then it is a continuation of the previous line and the two combined represent the entire part marking for that device.

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## TAPE AND REEL INFORMATION



\*All dimensions are nominal

| Device         | Package Type | Package Drawing | Pins | SPQ  | Reel Diameter (mm) | Reel Width W1 (mm) | A0 (mm) | B0 (mm) | K0 (mm) | P1 (mm) | W (mm) | Pin1 Quadrant |
|----------------|--------------|-----------------|------|------|--------------------|--------------------|---------|---------|---------|---------|--------|---------------|
| SN74BCT541ADWR | SOIC         | DW              | 20   | 2000 | 330.0              | 24.4               | 10.8    | 13.3    | 2.7     | 12.0    | 24.0   | Q1            |
| SN74BCT541ANSR | SOP          | NS              | 20   | 2000 | 330.0              | 24.4               | 8.4     | 13.0    | 2.5     | 12.0    | 24.0   | Q1            |

## TAPE AND REEL BOX DIMENSIONS



\*All dimensions are nominal

| Device         | Package Type | Package Drawing | Pins | SPQ  | Length (mm) | Width (mm) | Height (mm) |
|----------------|--------------|-----------------|------|------|-------------|------------|-------------|
| SN74BCT541ADWR | SOIC         | DW              | 20   | 2000 | 356.0       | 356.0      | 45.0        |
| SN74BCT541ANSR | SOP          | NS              | 20   | 2000 | 356.0       | 356.0      | 45.0        |

## TUBE



\*All dimensions are nominal

| Device          | Package Name | Package Type | Pins | SPQ | L (mm) | W (mm) | T (μm) | B (mm) |
|-----------------|--------------|--------------|------|-----|--------|--------|--------|--------|
| 5962-9074901M2A | FK           | LCCC         | 20   | 55  | 506.98 | 12.06  | 2030   | NA     |
| SN74BCT541AN    | N            | PDIP         | 20   | 20  | 506    | 13.97  | 11230  | 4.32   |
| SN74BCT541AN.A  | N            | PDIP         | 20   | 20  | 506    | 13.97  | 11230  | 4.32   |
| SNJ54BCT541FK   | FK           | LCCC         | 20   | 55  | 506.98 | 12.06  | 2030   | NA     |
| SNJ54BCT541FK.A | FK           | LCCC         | 20   | 55  | 506.98 | 12.06  | 2030   | NA     |

# MECHANICAL DATA

NS (R-PDSO-G\*\*)

PLASTIC SMALL-OUTLINE PACKAGE

14-PINS SHOWN



- NOTES:
- A. All linear dimensions are in millimeters.
  - B. This drawing is subject to change without notice.
  - C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15.

J (R-GDIP-T\*\*)

14 LEADS SHOWN

# CERAMIC DUAL IN-LINE PACKAGE



| PINS **<br>DIM | 14                     | 16                     | 18                     | 20                     |
|----------------|------------------------|------------------------|------------------------|------------------------|
| A              | 0.300<br>(7,62)<br>BSC | 0.300<br>(7,62)<br>BSC | 0.300<br>(7,62)<br>BSC | 0.300<br>(7,62)<br>BSC |
| B MAX          | 0.785<br>(19,94)       | .840<br>(21,34)        | 0.960<br>(24,38)       | 1.060<br>(26,92)       |
| B MIN          | —                      | —                      | —                      | —                      |
| C MAX          | 0.300<br>(7,62)        | 0.300<br>(7,62)        | 0.310<br>(7,87)        | 0.300<br>(7,62)        |
| C MIN          | 0.245<br>(6,22)        | 0.245<br>(6,22)        | 0.220<br>(5,59)        | 0.245<br>(6,22)        |



4040083/F 03/03

- NOTES:
- A. All linear dimensions are in inches (millimeters).
  - B. This drawing is subject to change without notice.
  - C. This package is hermetically sealed with a ceramic lid using glass frit.
  - D. Index point is provided on cap for terminal identification only on press ceramic glass frit seal only.
  - E. Falls within MIL STD 1835 GDIP1-T14, GDIP1-T16, GDIP1-T18 and GDIP1-T20.

## GENERIC PACKAGE VIEW

**FK 20**

**LCCC - 2.03 mm max height**

8.89 x 8.89, 1.27 mm pitch

LEADLESS CERAMIC CHIP CARRIER

This image is a representation of the package family, actual package may vary.  
Refer to the product data sheet for package details.

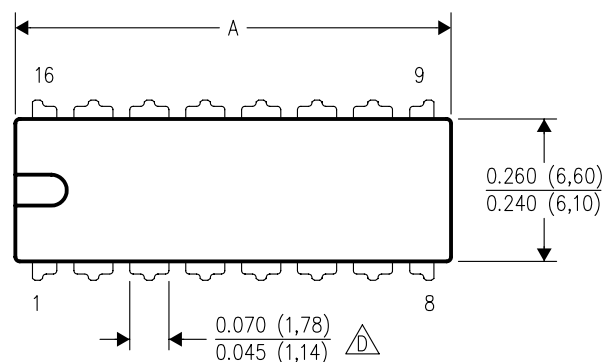


4229370VA\

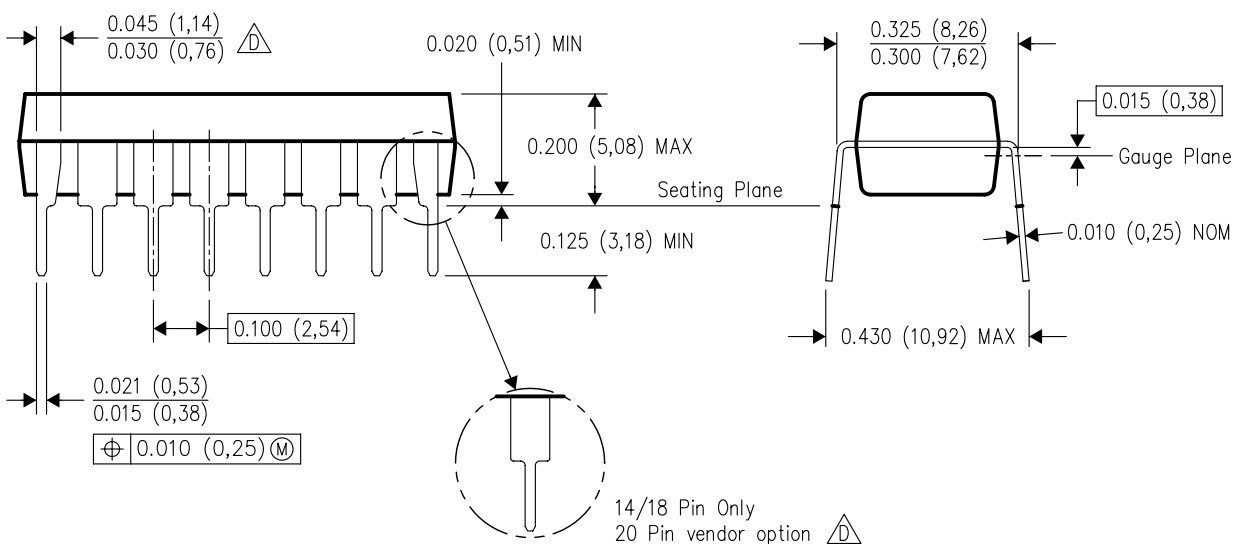
N (R-PDIP-T\*\*)

16 PINS SHOWN

## PLASTIC DUAL-IN-LINE PACKAGE

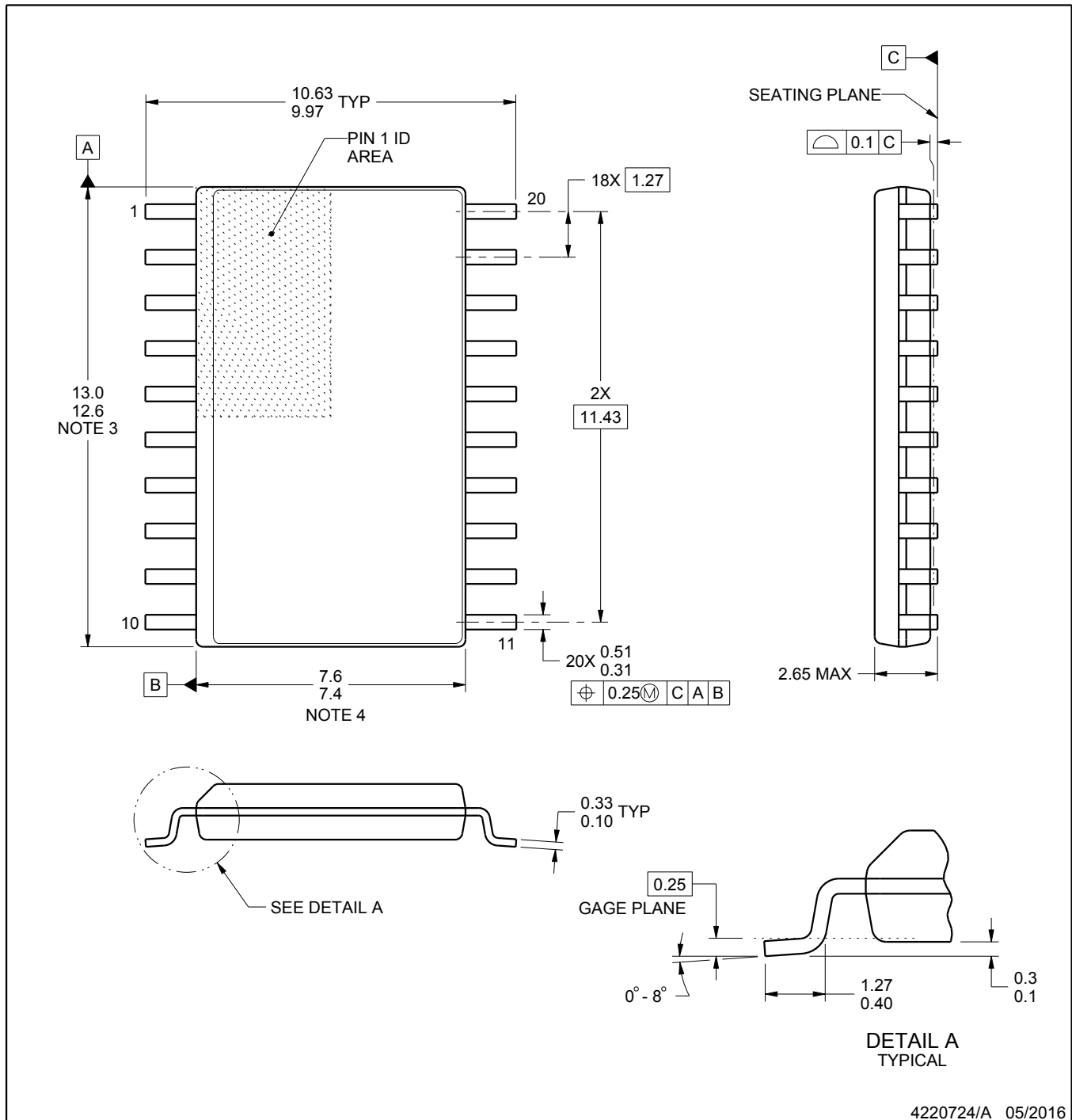


| PINS **<br>DIM      | 14               | 16               | 18               | 20               |
|---------------------|------------------|------------------|------------------|------------------|
| A MAX               | 0.775<br>(19,69) | 0.775<br>(19,69) | 0.920<br>(23,37) | 1.060<br>(26,92) |
| A MIN               | 0.745<br>(18,92) | 0.745<br>(18,92) | 0.850<br>(21,59) | 0.940<br>(23,88) |
| MS-001<br>VARIATION | AA               | BB               | AC               | AD               |



4040049/E 12/2002

- NOTES:
- A. All linear dimensions are in inches (millimeters).
  - B. This drawing is subject to change without notice.
  -  Falls within JEDEC MS-001, except 18 and 20 pin minimum body length (Dim A).
  -  The 20 pin end lead shoulder width is a vendor option, either half or full width.



4220724/A 05/2016

## NOTES:

1. All linear dimensions are in millimeters. Dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
2. This drawing is subject to change without notice.
3. This dimension does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.15 mm per side.
4. This dimension does not include interlead flash. Interlead flash shall not exceed 0.43 mm per side.
5. Reference JEDEC registration MS-013.

# EXAMPLE BOARD LAYOUT

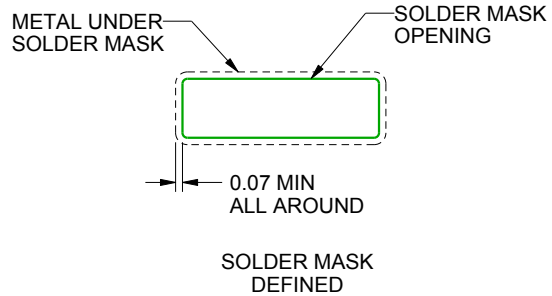
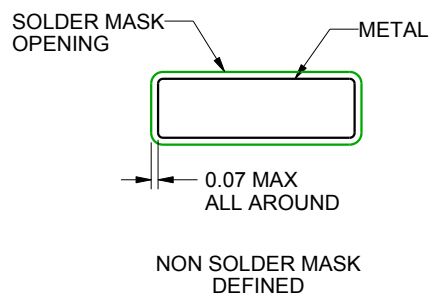
DW0020A

SOIC - 2.65 mm max height

SOIC



LAND PATTERN EXAMPLE  
SCALE:6X



SOLDER MASK DETAILS

4220724/A 05/2016

NOTES: (continued)

6. Publication IPC-7351 may have alternate designs.

7. Solder mask tolerances between and around signal pads can vary based on board fabrication site.

## EXAMPLE STENCIL DESIGN

DW0020A

SOIC - 2.65 mm max height

SOIC



SOLDER PASTE EXAMPLE  
BASED ON 0.125 mm THICK STENCIL  
SCALE:6X

4220724/A 05/2016

NOTES: (continued)

8. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
9. Board assembly site may have different recommendations for stencil design.

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